MLG0402P3N2CT000

RoHS Reach Halogen Free Pb Free

用途	一般等级
特点	Multilayer 积层 Non-Mag Core 非磁性核心(电介质陶瓷) High Q High Q
系列 型	MLG-P
状态	量产体制
品牌	TDK



	尺寸	
长度(L)	0.40mm ±0.02mm	
宽度 (W)	0.20mm ±0.02mm	
厚度 高低	0.20mm ±0.02mm	
推荐焊盘布局(A)	0.15mm to 0.20mm	
推荐焊盘布局(B)	0. 20mm Nom.	
推荐焊盘布局(C)	0.18mm to 0.20mm	

	电气特性
电感	3.2nH ± 0.2 nH at 500MHz
额定电流	180mA
直流电阻 [Typ.]	730 m Ω
直流电阻 [Max.]	1.1Ω
自我共振频率 [Min.]	7GHz
自我共振频率[Typ.]	9. 1GHz
Q [Min.]	8 at 500MHz
Q [Typ.]	

	其他
使用温度范围(包括自我温度上升)	-55∼125° C
焊接方法	回流
AEC-Q200	NO
包装形式	纸编带 (180mm卷筒、带宽 8mm)
包装个数	20000pcs
重量	0.00007g

[!] Images are for reference only and show exemplary products.

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 $^{!\ \}mbox{\footnotements}$. All specifications are subject to change without notice.



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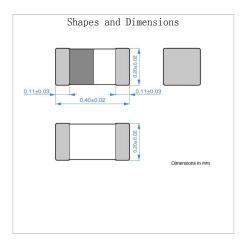
特性图表(这是参考数据,并不保证产品的特性。)

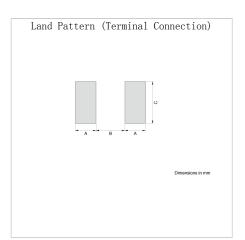
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Associated Images





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